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Resource detail
<u>Citations</u>
IEC 61249-3-5:1999 Materials for printed boards and other interconnecting
structures - Part 3-5: Sectional specification set for unreinforced base
materials, clad and unclad (intended for flexible printed boards) - Transfer
adhesive films
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Description
This part of IEC 61249 gives requirements for transfer adhesive films for use in the fabrication of flexible multilayer boards or fle

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